



processes



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Thermal Analysis, Modeling and Simulation in Engineering Processes

Guest Editors:

Dr. Leonardo Rosa Ribeiro da Silva

Faculdade de Engenharia
Mecânica, Laboratório de
Tecnologia em Atrito e Desgaste
—LTAD, Universidade Federal de
Uberlândia—UFU, Uberlândia
38400-902, MG, Brazil

Dr. Luiz Eduardo dos Santos Paes

Faculdade de Engenharia
Mecânica, Centro de Pesquisa e
Desenvolvimento em Processos
de Soldagem e Manufatura
Aditiva—LAPROSOLDA,
Universidade Federal de
Uberlândia—UFU, Uberlândia
38400-902, MG, Brazil

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Message from the Guest Editors

Engineering processes form the backbone of modern industrial and technological advancements, which include a wide range of activities involved in designing, developing, and optimizing systems, products, and infrastructure. In this field, thermal analysis plays a crucial role to provide us with a deep insight into the complex thermal phenomena. Understanding and controlling temperature distribution, heat transfer and thermal-induced effects are vital for optimizing process parameters, improving product quality and ensuring operational efficiency. The integration of thermal analysis techniques with advanced modeling and simulation approaches offers a powerful toolset to investigate and predict thermal behavior in manufacturing processes, such as casting, welding, additive manufacturing, machining and heat treatment.

This Special Issue invites researchers and practitioners to contribute their original research, reviews and case studies covering a wide range of topics, including innovative thermal analysis methods, advanced modeling techniques, experimental investigations, optimization strategies and real-world applications.



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Editor-in-Chief

Prof. Dr. Giancarlo Cravotto

Department of Drug Science and
Technology, University of Turin,
Via P. Giuria 9, 10125 Turin, Italy

Message from the Editor-in-Chief

Processes (ISSN 2227-9717) provides an advanced forum for process/system-related research in chemistry, biology, material, energy, environment, food, pharmaceutical, manufacturing and allied engineering fields. The journal publishes regular research papers, communications, letters, short notes and reviews. Our aim is to encourage researchers to publish their experimental, theoretical and computational results in as much detail as necessary. There is no restriction on paper length or number of figures and tables.

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Processes Editorial Office
MDPI, St. Alban-Anlage 66
4052 Basel, Switzerland

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